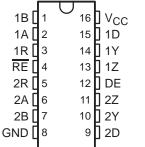
SLLS059D - FEBRUARY 1990 - REVISED MAY 1999

- Meet or Exceed the Requirements of ANSI Standards TIA/EIA-422-B and TIA/EIA-485-A and ITU Recommendations V.10 and V.11
- **Designed for Multipoint Bus Transmission** on Long Bus Lines in Noise Environments
- **Driver Positive- and Negative-Current** Limiting
- **Thermal Shutdown Protection**
- **Driver 3-State Outputs**
- **Receiver Common-Mode Input Voltage** Range of -12 V to 12 V
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Hysteresis . . . 50 mV Typ
- Receiver Input Impedance . . . 12 k Ω Min
- Receiver 3-State Outputs (SN751177 Only)
- **Operate From Single 5-V Supply**

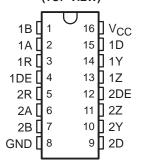
description

The SN751177 and SN751178 dual differential drivers and receivers are monolithic integrated circuits that are designed for balanced multipoint bus transmission at rates up to 10 Mbit/s. They are designed to improve the performance of full-duplex data communications over long bus lines and meet ANSI Standards TIA/EIA-422-B and TIA/EIA-485-A and ITU Recommendations V.10 and V.11.

SN751177 . . . N OR NS[†] PACKAGE (TOP VIEW)



SN751178 . . . N OR NS[†] PACKAGE (TOP VIEW)



† The NS package is only available taped and reeled.

The SN751177 and SN751178 driver outputs provide limiting for both positive and negative currents and thermal-shutdown protection from line-fault conditions on the transmission bus line.

The receiver features high input impedance of at least 12 k Ω , an input sensitivity of ± 200 mV over a common-mode input voltage range of -12 V to 12 V, and typical input hysteresis of 50 mV. Fail-safe design ensures that if the receiver inputs are open, the receiver outputs always will be high.

The SN751177 and SN751178 are characterized for operation from -20°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Function Tables

SN751177, SN751178 (each driver)

INPUT	PUT ENABLE		PUTS
D	DE	Υ	Z
Н	Н	Н	L
L	Н	L	Н
Х	L	Z	Z

H = high level, L = low level, X = irrelevant, Z = high impedance (off)

SN751177 (each receiver)

DIFFERENTIAL INPUTS A – B	ENABLE RE	OUTPUT R
V _{ID} ≥ 0.2 V	L	Н
–0.2 V < V _{ID} < 0.2 V	L	?
V _{ID} ≤ -0.2 V	L	L
X	Н	Z
Open	L	Н

H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

SN751178 (each receiver)

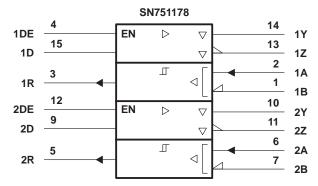
DIFFERENTIAL INPUTS A – B	OUTPUT R
V _{ID} ≥ 0.2 V	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$?
V _{ID} ≤ -0.2 V	L

H = high level, L = low level, ? = indeterminate



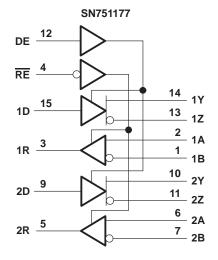
logic symbols†

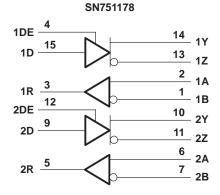
SN751177 12 EN1 DE 4 RE EN2 14 \triangleright 1 ▽ 1Y 15 1D 13 1 ▽ 1Z 2 I 1A 1R ▽ 2 \triangleleft 1 1B 10 \triangleright 1 ▽ 9 2Y 2D 11 1 ▽ **2Z** 6 ┚ 5 **2**A 2R ◁ ▽ 2 7 2B



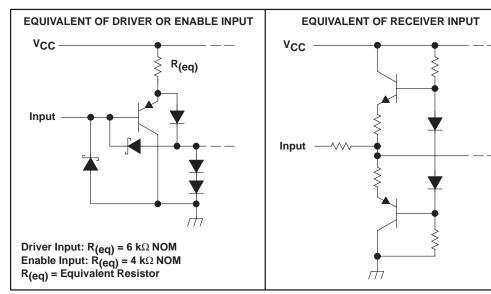
[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagrams (positive logic)





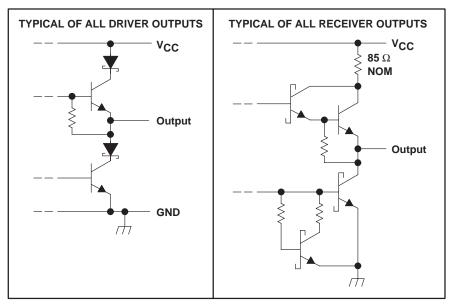
schematics of inputs



All resistor values are nominal.



schematics of outputs



All resistor values are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage, V _I (DE, RE, and D inputs)	
Receiver input voltage range, V _I (A or B inputs)	
Receiver differential input voltage range, V _{ID} (see Note 2)	
Driver output voltage range, VO	
Receiver low-level output current, I _{OL}	50 mA
Package thermal impedance, θ_{JA} (see Note 3): N package	
NS package	
Storage temperature range, T _{Stq}	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential input voltage, are with respect to the network ground terminal.
 - 2. Differential input voltage is measured at the noninverting terminal with respect to the inverting terminal.
 - 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



SN751177, SN751178 DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

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recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
High-level input voltage, VIH	DE <u>DE</u> ID :	2			V
Low-level input voltage, V _{IL}	DE, RE, and D inputs			0.8	V
Common-mode output voltage, VOC		_7 [†]		12	V
High-level output current, IOH	Driver			-60	mA
Low-level output current, IOL				60	mA
Common-mode input voltage, V _{IC}				±12	V
Differential input voltage, V _{ID}	Receiver			±12	V
High-level output current, IOH	Receiver			-400	μΑ
Low-level output current, IOL				16	mA
Operating free-air temperature, T _A		-20		85	°C

[†] The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode output and threshold voltage levels only.

DRIVER SECTIONS

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
VIK	Input clamp voltage	I _I = -18 mA					-1.5	V
Vон	High-level output voltage	V _{IH} = 2 V,	V _{IL} = 0.8 V,	$I_{OH} = -33 \text{ mA}$		3.7		V
VOL	Low-level output voltage	V _{IH} = 2 V,	$V_{IL} = 0.8 V$	$I_{OH} = 33 \text{ mA}$		1.1		V
VOD1	Differential output voltage	IO = 0			1.5		6	V
V _{OD2}	Differential output voltage	$R_L = 100 \Omega$,	See Figure 1		2 or 1/2 V _{O[}	D1 [‡]		V
		$R_L = 54 \Omega$,	See Figure 1		1.5		5	
V _{OD3}	Differential output voltage	See Note 4			1.5		5	V
Δ VOD	Change in magnitude of differential output voltage (see Note 5)						±0.2	٧
Voc	Common-mode output voltage	$R_L = 54 \Omega$ or 1	100 Ω,	See Figure 1	-1§		3	V
Δ VOC	Change in magnitude of common-mode output voltage (see Note 5)						±0.2	V
IO	Output current with power off	$V_{CC} = 0$,	$V_O = -7 \text{ V to}$	12 V			±100	μΑ
loz	High-impedance-state output current	$V_0 = -7 \text{ V to } 1$	12 V				±100	μΑ
lіН	High-level input current	V _{IH} = 2.7 V					20	μΑ
IIL	Low-level input current	V _{IL} = 0.4 V					-100	μΑ
		$V_0 = -7 \text{ V}$					-250	
los	Short-circuit output current (see Note 6)	VO = VCC					250	mA
		V _O = 12 V					250	
loo	Supply current	No load	Outputs enabl	ed		80	110	mA
Icc	очрру очнени	Outputs disabled			50	80	ША	

NOTES: 4. See TIA/EIA-485-A Figure 3.5, Test Termination Measurement 2

- 5. Δ|VOD| and Δ|VOC| are the changes in magnitude of VOD and VOC, respectively, that occur when the input is changed from a high level to a low level.
- 6. Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

switching characteristics at V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C

	PARAMETER	TEST CO	ONDITIONS	MIN	TYP	MAX	UNIT	
td(OD)	Differential output delay time	$R_1 = 54 \Omega$	See Figure 3		20	25	ns	
t _t (OD)	Differential output transition time	11(_ = 54 52,	See Figure 5		27	35	ns	
^t PLH	Propagation delay time, low- to high-level output	P 27 O	$R_1 = 27 \Omega$	See Figure 4		20	25	ns
tPHL	Propagation delay time, high- to low-level output	K = 27.52,	See Figure 4		20	25	ns	
^t PZH	Output enable time to high level	$R_L = 110 \Omega$,	See Figure 5		80	120	ns	
tPZL	Output enable time to low level	$R_L = 110 \Omega$,	See Figure 6		40	60	ns	
^t PHZ	Output disable time from high level	$R_L = 110 \Omega$,	See Figure 5		90	120	ns	
tPLZ	Output disable time from low level	$R_L = 110 \Omega$,	See Figure 6		30	45	ns	



[†] All typical values are at V_{CC} = 5 V and T_A = 25°C. ‡ The minimum V_{OD2} with a 100- Ω load is either 1/2 V_{OD1} or 2 V, whichever is greater.

[§] The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode output and threshold voltage levels only.

SYMBOL EQUIVALENTS

DATA-SHEET PARAMETER	TIA/EIA-422-B	TIA/EIA-485-A
Vod1	Vo	VO
IVOD2I	$V_t (R_L = 100 \Omega)$	$V_t (R_L = 54 \Omega)$
IVOD3l		V _t (Test Termination Measurement 2)
Δ V _{OD}	$ V_t - \overline{V}_t $	$ V_t - \overline{V}_t $
Voc	V _{OS}	V _{OS}
∆ Voc	Vos - Vos	Vos−Vos
los	I _{sa} , I _{sb}	
lo	$ I_{xa} , I_{xb} $	l _{ia} , l _{ib}

RECEIVER SECTIONS

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER		TEST CO	NDITIONS	MIN	TYP [†]	MAX	UNIT
V _{IT+}	Positive-going input threshold voltage		$V_0 = 2.7 V$,	$I_{O} = -0.4 \text{ mA}$			0.2	V
V _{IT} _	Negative-going input threshold voltage		$V_0 = 0.5 V$,	I _O = 16 mA	-0.2‡			V
V _{hys}	Input hysteresis voltage (V _{IT+} - V _{IT-})					50		mV
VIK	Enable clamp voltage	SN751177	I _I = -18 mA				-1.5	V
Vон	High-level output voltage		V _{ID} = 200 mV,	I _{OH} = -400 μA	2.7			V
\/	Low level output voltage		\/ 200 m\/	IOL = 8 mA			0.45	V
VOL	Low-level output voltage		V _{ID} = -200 mV	I _{OL} = 16 mA			0.5	V
loz	High-impedance-state output current	SN751177	$V_0 = 0.4 \text{ V to } 2.4 \text{ V}$				±20	μΑ
l	Line input current (see Note 7)		Other input et 0 V	V _I = 12 V			1	mA
1	Line input current (see Note 7)		Other input at 0 V	V _I = −7 V			-0.8	mA
lіН	High-level enable input current	SN751177	V _{IH} = 2.7 V				20	μА
I∣L	Low-level enable input current	SN751177	V _{IL} = 0.4 V				-100	μА
los	Short-circuit output current (see Note 6)		·	-15		-85	μΑ
Icc	Supply current		No load,	Outputs enabled		80	110	mA
rį	Input resistance			·	12			kΩ

 $[\]uparrow$ All typical values are at V_{CC} = 5 V and T_A = 25°C.



[‡] The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode output and threshold voltage levels only.

NOTES: 6. Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

^{7.} Refer to ANSI Standards TIA/EIA-422-B, TIA/EIA-423-A, and TIA/EIA-485-A for exact conditions.

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switching characteristics at V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

	PARAMETER		TEST CONDIT	TONS	MIN	TYP	MAX	UNIT
t _{PLH}	Propagation delay time, low- to high-level	output	V _{ID} = -1.5 V to 1.5 V,	See Figure 7		20	35	ns
tPHL	tPHL Propagation delay time, high- to low-level output		V _{ID} = −1.5 V to 1.5 V, See Figure 7			22	35	ns
^t PZH	Output enable time to high level					17	25	ns
tPZL	Output enable time to low level	SN751177	See Figure 8			20	27	ns
tPHZ	Output disable time from high level	31177	See Figure 8			25	40	ns
t _{PLZ}	Output disable time from low level					30	40	ns

PARAMETER MEASUREMENT INFORMATION

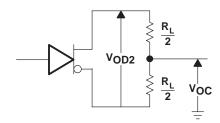


Figure 1. Driver Test Circuit, V_{OD} and V_{OC}

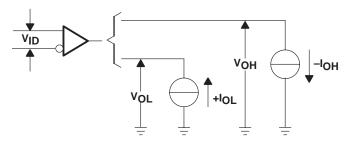
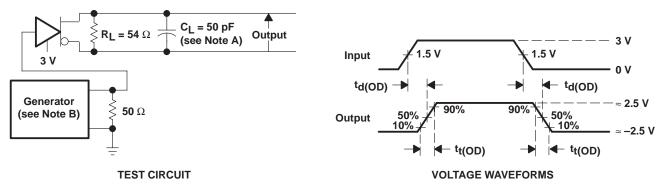


Figure 2. Receiver Test Circuit, VOH and VOL



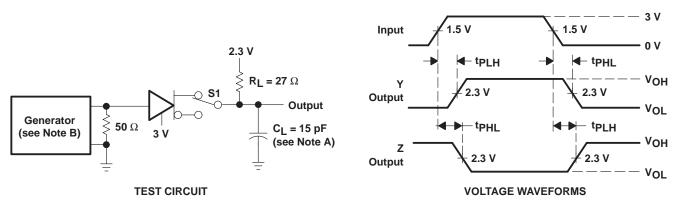
NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, 50% duty cycle, Z_{Q} = 50 Ω , t_{f} \leq 6 ns, t_{f} \leq 6 ns.

Figure 3. Driver Differential Output-Delay and Transition-Time Test Circuit and Voltage Waveforms



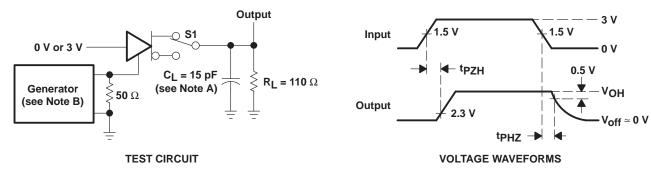
PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $Z_O = 50~\Omega$, $t_f \leq 6$ ns. $t_f \leq 6$ ns.

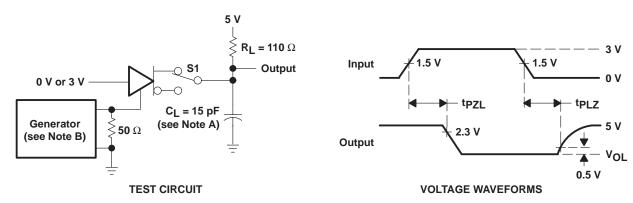
Figure 4. Driver Propagation-Time Test Circuit and Voltage Waveforms



NOTES: A. C_I includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $Z_O = 50~\Omega$, $t_f \leq$ 6 ns. $t_f \leq$ 6 ns.

Figure 5. Driver Enable- and Disable-Time Test Circuit and Voltage Waveforms



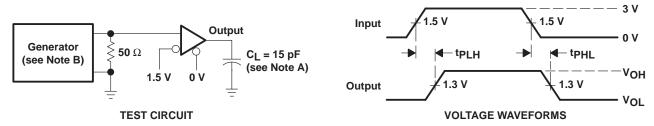
NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $Z_O = 50 \Omega$, $t_f \leq 6$ ns, $t_f \leq 6$ ns.

Figure 6. Driver Enable- and Disable-Time Test Circuit and Voltage Waveforms



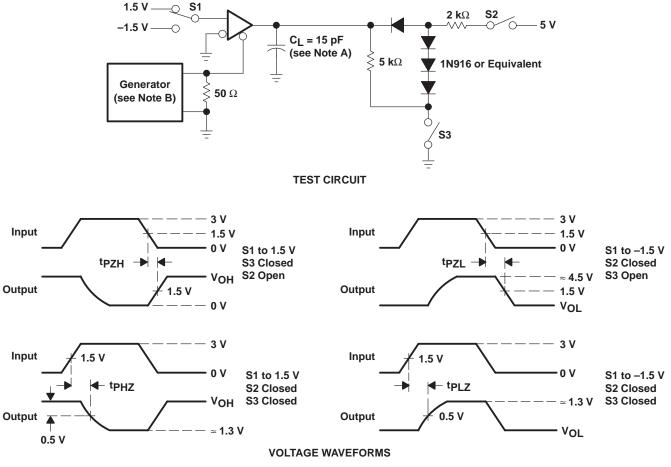
PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $Z_O = 50~\Omega$, $t_f \leq 6$ ns. $t_f \leq 6$ ns.

Figure 7. Receiver Propagation-Time Test Circuit and Voltage Waveforms



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $Z_O = 50 \ \Omega$, $t_f \leq 6$ ns. $t_f \leq 6$ ns.

Figure 8. Receiver Output Enable- and Disable-Time Test Circuit and Voltage Waveforms







.com 4-Jun-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN751177N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN751177NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN751177NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN751177NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN751177NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN751178N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN751178NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN751178NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN751178NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN751178NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

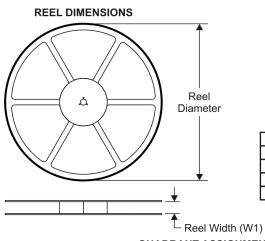
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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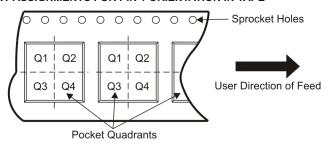
TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

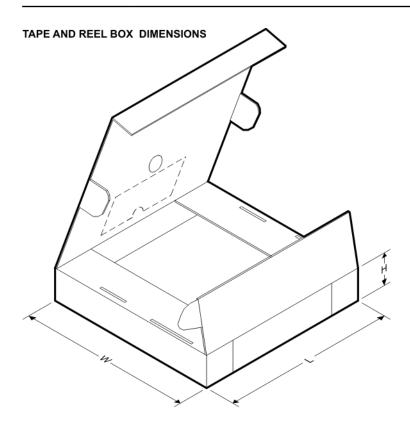
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN751177NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN751178NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN751177NSR	SO	NS	16	2000	346.0	346.0	33.0
SN751178NSR	SO	NS	16	2000	346.0	346.0	33.0

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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